Roll No.					Total No. of Pages: 0

Total No. of Questions: 09

# B.Tech.(CSE)/(IT) (Sem.-5) DATA BASE MANAGEMENT SYSTEM

Subject Code: CS-305 Paper ID: [A0466]

Time: 3 Hrs. Max. Marks: 60

#### **INSTRUCTION TO CANDIDATES:**

- SECTION-A is COMPULSORY consisting of TEN questions carrying TWO marks each.
- 2. SECTION-B contains FIVE questions carrying FIVE marks each and students have to attempt any FOUR questions.
- 3. SECTION-C contains THREE questions carrying TEN marks each and students have to attempt any TWO questions.

## **SECTION-A**

## 1. Write briefly:

- a) Give the usage of rename operation with an example.
- b) With an example explain what a derived attribute is?
- c) List the SQL statements used for transaction control.
- d) Define functional dependency.
- e) What do you mean by weak entity sets?
- f) Define Physical schema and Logical schema.
- g) Differentiate between procedural and non procedural language.
- h) Define integrity constraints.
- i) Give various symbols used in E.R. diagram.
- i) Describe statistical database security.

**1** M-56525 (S2)-789

### **SECTION-B**

- 2. Explain the need of normalization in database.
- 3. Discuss the various disadvantages in the file system and explain how it can be overcome by the database system.
- 4. What is E-R model? What is the use of E-R model? Draw any E-R diagram of your choice. Specify different entities, their attributes, cardinalities and degrees of the relationships in the E-R model.
- 5. What do you mean by deadlock? How it can be removed?
- 6. What is the purpose of RAID? Which level of the RAID is best? Why?

## **SECTION-C**

- 7. Diagrammatically illustrate and discuss the steps involved in processing a query. (10)
- 8. a) What is Lossless-join decomposition? (2)
  - b) Explain two types of Participation constraints. (3)
  - c) What is the difference between tuple relational calculus and domain relational calculus? (5)
- 9. Explain deferred database modifications and immediate database modification recovery techniques. (10)

**2** | M-56525 (S2)-789